EUROPEAN PATENT OFFICE U.S. PATENT AND TRADEMARK OFFICE

CPC NOTICE OF CHANGES 1832

DATE: JANUARY 1, 2026

PROJECT MP12738

The following classification changes will be effected by this Notice of Changes:

Action	Subclass	Group(s)
SCHEME:		
Titles Changed:	H05K	1/16, 1/18, 1/181, 1/182, 1/183, 1/184, 1/185, 1/189
DEFINITIONS:		
Definitions Modified:	H05K	1/18

No other subclasses/groups are impacted by this Notice of Changes.

This Notice of Changes includes the following [Check the ones included]:				
1. CLASSIFICATION SCHEME CHANGES				
A. N	New, Modified or Deleted Group(s)			
☐ B. 1	New, Modified or Deleted Warning(s)			
☐ C. N	New, Modified or Deleted Note(s)			
D. 1	New, Modified or Deleted Guidance Heading(s)			
2. DEFINITIONS				
A . 1	New or Modified Definitions (Full definition template)			
□ B. 1	Modified or Deleted Definitions (Definitions Quick Fix)			
3. REVISIO	N CONCORDANCE LIST (RCL)			
4. CHANGE	ES TO THE CPC-TO-IPC CONCORDANCE LIST (CICL)			
5. CHANGE	ES TO THE CROSS-REFERENCE LIST (CRL)			

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1. CLASSIFICATION SCHEME CHANGES

A. New, Modified or Deleted Group(s)

SUBCLASS H05K - PRINTED CIRCUITS; CASINGS OR CONSTRUCTIONAL DETAILS OF ELECTRIC APPARATUS; MANUFACTURE OF ASSEMBLAGES OF ELECTRICAL COMPONENTS

Type*	<u>Symbol</u>	Indent Level Number of dots (e.g. 0, 1, 2)	Title "CPC only" text should normally be enclosed in {curly brackets}**	Transferred to [#]
M	H05K1/16	1	incorporating printed electric components, e.g. printed resistors, capacitors or inductors	
M	H05K1/18	1	structurally associated with non-printed electric components (H05K 1/16 takes precedence)	
M	H05K1/181	2	associated with surface mounted components	
M	H05K1/182	2	associated with components mounted in printed circuit boards [PCB], e.g. insert-mounted components [IMC]	
M	H05K1/183	3	associated with components mounted in and supported by recessed areas of the PCBs	
M	H05K1/184	3	associated with components inserted in holes through the PCBs and wherein terminals of the components are connected to printed contacts on the walls of the holes or at the edges thereof or protruding over or into the holes	
M	H05K1/185	3	associated with components encapsulated in the insulating substrate of the PCBs; associated with components incorporated in internal layers of multilayer circuit boards	
M	H05K1/189	2	characterised by the use of flexible or folded printed circuits	

*N = new entries where reclassification into entries is involved; C = entries with modified file scope where reclassification of documents from the entries is involved; Q = new entries which are firstly populated with documents via administrative transfers from deleted (D) entries. Afterwards, the transferred documents into the Q entry will either stay or be moved to more appropriate entries, as determined by intellectual reclassification; T = existing entries with enlarged file scope, which receive documents from C or D entries, e.g. when a limiting reference is removed from the entry title; M = entries with no change to the file scope (no reclassification); D = deleted entries; F = frozen entries will be deleted once reclassification of documents from the entries is completed; U = entries that are unchanged.

NOTES:

- **No {curly brackets} are used for titles in CPC only <u>subclasses</u>, e.g. C12Y, A23Y; 2000 series symbol titles of groups found at the end of schemes (orthogonal codes); or the Y section titles. The {curly brackets} are used for 2000 series symbol titles found interspersed throughout the main trunk schemes (breakdown codes).
- U groups: it is obligatory to display the required "anchor" symbol (U group), i.e. the entry immediately preceding a new group or an array of new groups to be created (in case new groups are not clearly subgroups of C-type groups). Always include the symbol, indent level and title of the U group in the table above.

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- All entry types should be included in the scheme changes table above for better understanding of the overall scheme change picture. Symbol, indent level, and title are required for all types.
- "Transferred to" column <u>must</u> be completed for all C, D, F, and Q type entries. F groups will be deleted once reclassification is completed.
- When multiple symbols are included in the "Transferred to" column, avoid using ranges of symbols in order to be as precise as possible.
- For administrative transfer of documents, the following text should be used: "<administrative transfer to XX>", "<administrative transfer to XX and YY simultaneously>", or "<administrative transfer to XX, YY, ...and ZZ simultaneously>" when administrative transfer of the same documents is to more than one place.
- Administrative transfer to main trunk groups is assumed to be the source allocation type, unless otherwise indicated.
- Administrative transfer to 2000/Y series groups is assumed to be "additional information".
- If needed, instructions for allocation type should be indicated within the angle brackets using the abbreviations "ADD" or "INV": <administrative transfer to XX ADD>, <administrative transfer to XX INV>, or <administrative transfer to XX ADD, YY INV, ... and ZZ ADD simultaneously>.
- In certain situations, the "D" entries of 2000-series or Y-series groups may not require a destination ("Transferred to") symbol, however it is required to specify "<no transfer>" in the "Transferred to" column for such cases.
- For finalization projects, the deleted "F" symbols should have <no transfer> in the "Transferred to" column.
- For more details about the types of scheme change, see CPC Guide.

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2. A. DEFINITIONS (modified)

H05K1/18

References

Replace: The existing Limiting references table with the following updated table.

Limiting references

This place does not cover:

Incorporating printed electric components, e.g. printed resistors,	H05K 1/16
capacitors or inductors	

<u>Insert</u>: The following new Informative references table.

Informative references:

Attention is drawn to the following places, which may be of interest for search:

Thermal arrangements, e.g. for cooling, heating or preventing overheating	H05K 1/0201
Reduction of cross-talk, noise or electromagnetic interference using auxiliary mounted passive components or auxiliary substances	H05K 1/023
Printed circuits associated with mounted high frequency components	H05K 1/0243

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4. CHANGES TO THE CPC-TO-IPC CONCORDANCE LIST (CICL)

<u>CPC</u>	<u>IPC</u>	Action*
H05K 1/181	H05K 1/181	UPDATE
H05K 1/182	H05K 1/182	UPDATE
H05K 1/183	H05K 1/183	UPDATE
H05K 1/184	H05K 1/184	UPDATE
H05K 1/185	H05K 1/185	UPDATE
H05K 1/186	H05K 1/185	UPDATE
H05K 1/187	H05K 1/185	UPDATE
H05K 1/188	H05K 1/185	UPDATE
H05K 1/189	H05K 1/189	UPDATE

*Action column:

- For an (N) or (Q) entry, provide an IPC symbol and complete the Action column with "NEW."
- For an existing CPC main trunk entry or indexing entry where the existing IPC symbol needs to be changed, provide an updated IPC symbol and complete the Action column with "UPDATED."
- For a (D) CPC entry or indexing entry complete the Action column with "DELETE." IPC symbol does not need to be included in the IPC column.
- For an (N) 2000 series CPC entry which is positioned within the main trunk scheme (breakdown code) provide an IPC symbol and complete the action column with "NEW".
- For an (N) 2000 series CPC entry positioned at the end of the CPC scheme (orthogonal code), with no IPC equivalent, complete the IPC column with "CPCONLY" and complete the action column with "NEW".

NOTES:

- F symbols are <u>not</u> included in the CICL table above.
- T and M symbols are not included in the CICL table above unless a change to the existing IPC is desired.